

Buchanan | Buchanan 6 Series

TE Internal #: 796988-5

Barrier Strips, Tri-Barrier, Printed Circuit Pin, Wire-to-Board, 3 Position, 9.53 mm [.375 in] Centerline, 1 Row, Buchanan 6 Series

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Connectors > Terminal Blocks & Strips > Barrier Strips











Barrier Strip Style: Tri-Barrier

Bottom Termination Type: Printed Circuit Pin

Connector System: Wire-to-Board

Number of Positions: 3

Centerline (Pitch): 9.53 mm [.375 in]

Features

Product Type Features

Block Style	Flat Bottom with standoffs
Connector System	Wire-to-Board
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Levels	1
Number of Positions	3
Number of Rows	1
Electrical Characteristics	
Operating Voltage	300 V
Body Features	
Primary Product Color	Black
Product Orientation	Vertical
Barrier Strip Style	Tri-Barrier
Contact Features	



PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Current Rating (Max)	25 A
Termination Features	
Bottom Termination Type	Printed Circuit Pin
Mechanical Attachment	
Screw Head Type	Combo Phil-Slot
Screw Plating Material	Zinc Chromate
Screw Material	Steel
Top Termination Type	Binding Combo Head
Mounting Options	End Positions Empty
Thread Size	6-32
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	Thermoplastic
Centerline (Pitch)	9.53 mm[.375 in]
Dimensions	
Product Length	49.17 mm[1.936 in]
Wire Size	.326 – 3.31 mm²
Operation/Application	
Circuit Application	Power
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	200
Packaging Method	Package

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold



EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Wave solder capable to 265°C

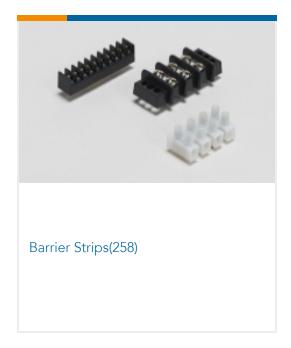
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | Buchanan 6 Series



Customers Also Bought

















Documents

Product Drawings

6PCV-03-009

English

CAD Files

Customer View Model

ENG_CVM_CVM_796988-5_M.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_796988-5_M.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_796988-5_M.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

1-1773458-2_BARRIER_STRIPS_QUICK_REFERENCE_GUIDE

English

Agency Approvals

UL

English